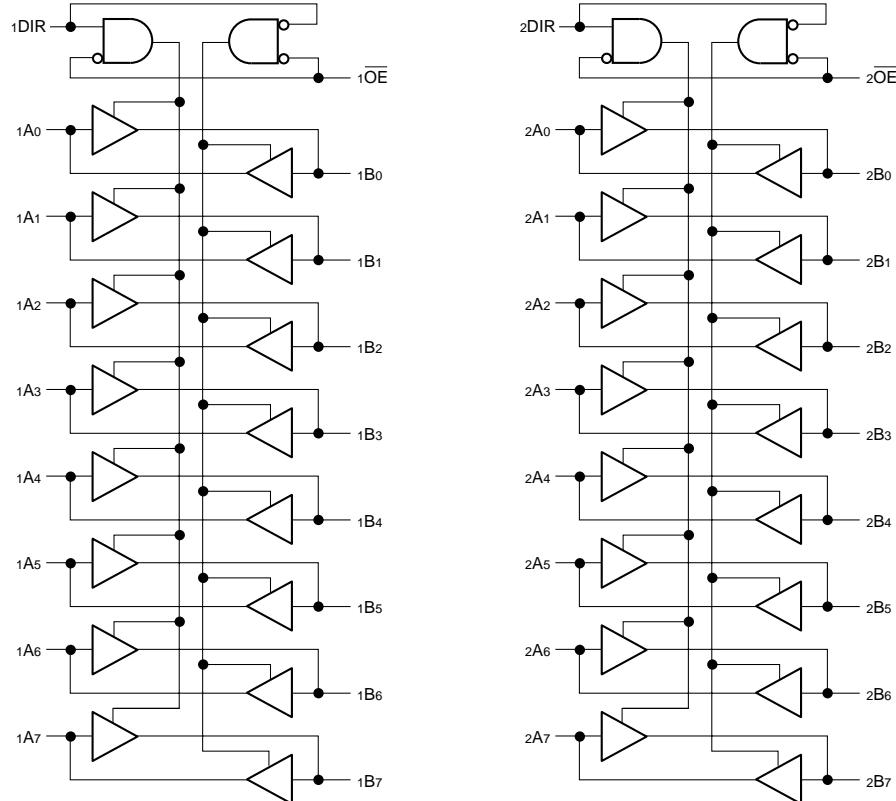


Product Features

- Compatible with LCX™ and LVT™ families of products
- Supports 5V Tolerant Mixed Signal Mode Operation
 - Input can be 3V or 5V
 - Output can be 3V or connected to 5V bus
- Advanced Low Power CMOS Operation
- Excellent output drive capability:
Balanced drives (6 mA sink and source)
- Pin compatible with industry standard double-density pinouts
- Low Noise, overshoot/undershoot, $\pm 1\text{V}$ Max.
- Low ground bounce outputs
- Hysteresis on all inputs
- Industrial operating temperature range: -40°C to $+85^\circ\text{C}$
- Multiple center pins and distributed Vcc/GND pins minimize switching noise
- Packages available:
 - 48-pin 240 mil wide thin plastic TSSOP (A)
 - 48-pin 300 mil wide plastic SSOP (V)

Logic Block Diagram



Product Description

Pericom Semiconductor's PI74LPT series of logic circuits are produced using the Company's advanced 0.6 micron CMOS technology, achieving industry leading speed grades.

The PI74LPT16L245 is a low noise 16-bit bidirectional transceiver designed for asynchronous two-way communication between data buses. The direction control input pin (xDIR) determines the direction of data flow through the bidirectional transceiver. The Direction and Output Enable controls are designed to operate this device as either two independent 8-bit transceivers or one 16-bit transceiver. The output enable (\bar{OE}) input, when HIGH, disables both A and B ports by placing them in HIGH Z condition.

The PI74LPT16L245 can be driven from either 3.3V or 5.0V devices allowing this device to be used as a translator in a mixed 3.3/5.0V system.

Product Pin Description

Pin Name	Description
xOE	3-State Output Enable Inputs (Active LOW)
xDIR	Direction Control Input
xAx	Side A Inputs or 3-State Inputs
xBx	Side B Outputs or 3-State Outputs
GND	Ground
Vcc	Power

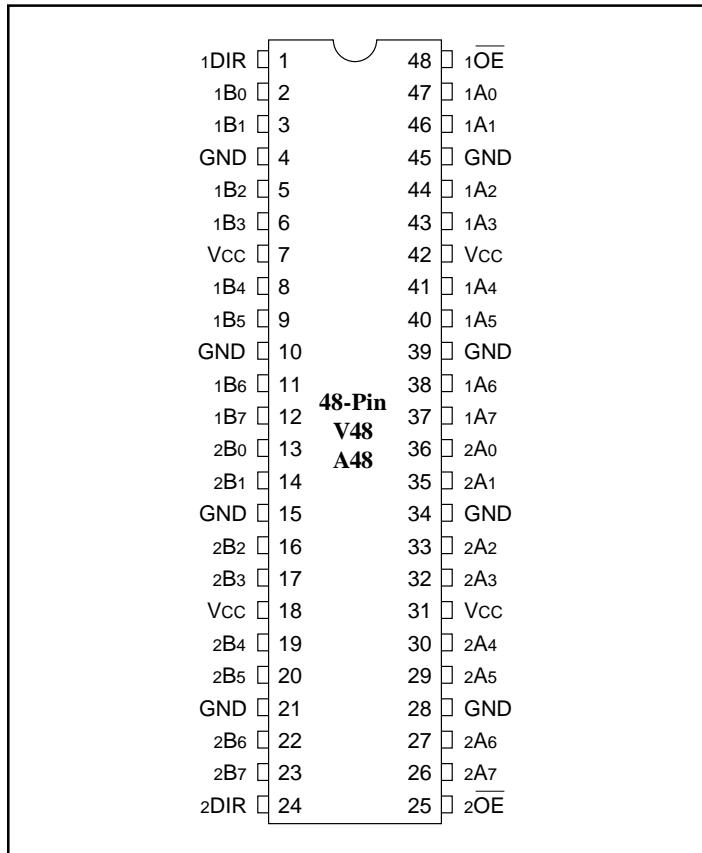
Truth Table

Inputs ⁽¹⁾		Outputs ⁽¹⁾
xOE	xDIR	
L	L	Bus B Data to Bus A
L	H	Bus A Data to Bus B
H	X	Z

Note:

1. H = High Voltage Level, X = Don't Care,
L = Low Voltage Level, Z = High Impedance

Product Pin Configuration



Capacitance ($T_A = 25^\circ C$, $f = 1 \text{ MHz}$)

Parameters ⁽¹⁾	Description	Test Conditions	Typ	Max.	Units
C_{IN}	Input Capacitance	$V_{IN} = 0 \text{ V}$	4.5	6	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0 \text{ V}$	5.5	8	pF

Note:

1. This parameter is determined by device characterization but is not production tested.

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-55°C to +125°C
Ambient Temperature with Power Applied	-40°C to +85°C
Supply Voltage to Ground Potential (Inputs & Vcc Only)	-0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only)	-0.5V to +7.0V
DC Input Voltage	-0.5V to +7.0V
DC Output Current	120 mA
Power Dissipation	1.0W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, TA = -40°C to +85°C, VCC = 2.7V to 3.6V)

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
VIH	Input HIGH Voltage (Input pins)	Guaranteed Logic HIGH Level		2.2	—	5.5	V
	Input HIGH Voltage (I/O pins)			2.0	—	5.5	V
VL	Input LOW Voltage (Input and I/O pins)	Guaranteed Logic LOW Level		-0.5	—	0.8	V
I _H	Input HIGH Current (Input pins)	V _{CC} =Max.	V _{IN} =5.5V	—	—	±1	µA
	Input HIGH Current (I/O pins)	V _{CC} =Max.	V _{IN} =V _{CC}	—	—	±1	µA
I _L	Input LOW Current (Input pins)	V _{CC} =Max.	V _{IN} =GND	—	—	±1	µA
	Input LOW Current (I/O pins)	V _{CC} =Max.	V _{IN} =GND	—	—	±1	µA
IOZH	High Impedance Output Current	V _{CC} =Max.	V _{OUT} =5.5V	—	—	±1	µA
IOZL	(3-State Output pins)	V _{CC} =Max.	V _{OUT} =GND	—	—	±1	µA
VIK	Clamp Diode Voltage	V _{CC} =Min., I _{IN} =-18 mA		—	-0.7	-1.2	V
IODH	Output HIGH Current	V _{CC} =3.3V, V _{IN} =VIH or VIL, VO=1.5V ⁽³⁾		-15	-28	-60	mA
IODL	Output LOW Current	V _{CC} =3.3V, V _{IN} =VIH or VIL, VO=1.5V ⁽³⁾		20	30	60	mA
VOH	Output HIGH Voltage	V _{CC} =Min., V _{IN} =VIH or VIL	I _{OH} =-0.1 mA	V _{CC} -0.2			V
VOL	Output LOW Voltage	V _{CC} =3.0V, V _{IN} =VIH or VIL	I _{OH} =-6 mA	2.4 ⁽⁵⁾	2.6	—	
			I _{OH} =-12 mA	2.0	—	—	
		V _{CC} =Min. V _{IN} =VIH or VIL	I _{OL} =0.1 mA	—	—	0.2	V
			I _{OL} =6 mA	—	0.3	0.5	V
Ios	Short Circuit Current ⁽⁴⁾	V _{CC} =Max. ⁽³⁾ , V _{OUT} =GND		-30	-56	-120	mA
IOFF	Power Down Disable	V _{CC} =0V, V _{IN} or V _{OUT} ≤4.5V		—	—	±100	µA
V _H	Input Hysteresis			—	150	—	mV

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 3.3V, +25°C ambient and maximum loading.
3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
4. This parameter is guaranteed but not tested.
5. VOH = V_{CC} - 0.6V at rated current.

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max.	V _{IN} = GND or V _{CC}		0.1	10	μA
ΔI _{CC}	Quiescent Power Supply Current TTL Inputs HIGH	V _{CC} = Max.	V _{IN} = V _{CC} - 0.6V ⁽³⁾		2.0	30	μA
I _{CCD}	Dynamic Power Supply ⁽⁴⁾	V _{CC} = Max., Outputs Open x _{OE} = x _{DIR} = GND One Bit Toggling 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND		50	75	μA/ MHz
I _C	Total Power Supply Current ⁽⁶⁾	V _{CC} = Max., Outputs Open f _I = 10 MHz 50% Duty Cycle x _{OE} = x _{DIR} = GND One Bit Toggling	V _{IN} = V _{CC} - 0.6V V _{IN} = GND		0.5	0.8	mA
		V _{CC} = Max., Outputs Open f _I = 2.5 MHz 50% Duty Cycle x _{OE} = x _{DIR} = GND 16 Bits Toggling	V _{IN} = V _{CC} - 0.6V V _{IN} = GND		2.0	3.3 ⁽⁵⁾	

Notes:

1. For Max. or Min. condition, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at V_{CC} = 3.3V, +25°C ambient.
3. Per TTL driven input; all other inputs at V_{CC} or GND.
4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
5. Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
6. I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}

$$I_C = I_{CC} + \Delta I_{CC} D_{HNT} + I_{CCD} (f_{CP}/2 + f_I N_I)$$

I_{CC} = Quiescent Current (I_{CCL}, I_{CCH} and I_{CCZ})

ΔI_{CC} = Power Supply Current for a TTL High Input

D_H = Duty Cycle for TTL Inputs High

N_T = Number of TTL Inputs at D_H

I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)

N_{CP} = Number of Clock Inputs at f_{CP}

f_I = Input Frequency

N_I = Number of Inputs at f_I

All currents are in millamps and all frequencies are in megahertz.

Switching Characteristics over Operating Range⁽¹⁾

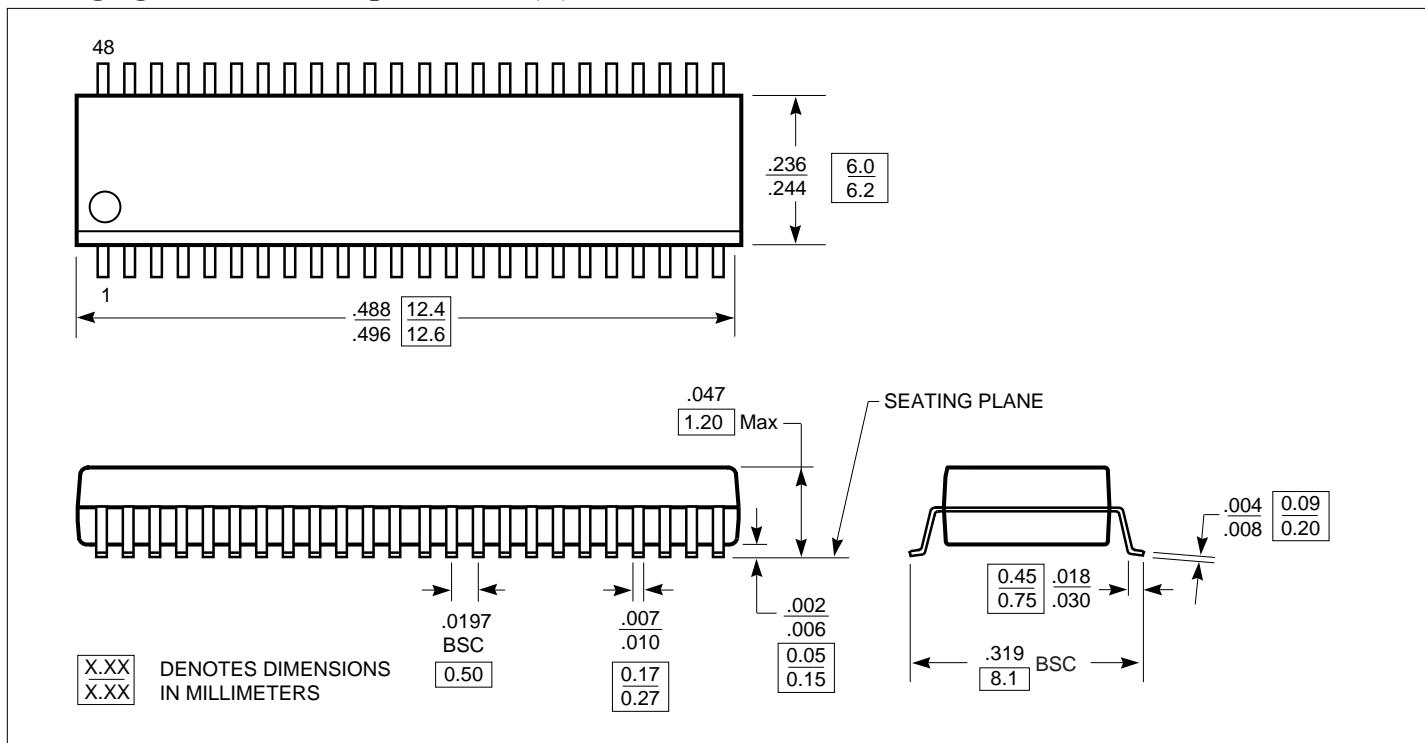
Parameters	Description	Conditions ⁽²⁾	LPT16L245		LPT16L245A		LPT16L245C		Units	
			Com.		Com.		Com.			
			Min. ⁽³⁾	Max.	Min. ⁽³⁾	Max.	Min. ⁽³⁾	Max.		
tPLH tPHL	Propagation Delay A to B, B to A	CL = 50 pF RL = 500Ω	1.5	5.2	1.5	4.6	1.5	5.5 ⁽⁶⁾	ns	
tpZH tpZL	Output Enable Time xOE to A or B		1.5	7.2	1.5	6.2	1.5	5.8	ns	
tPHZ tPLZ	Output Disable Time ⁽⁴⁾ xOE to A or B		1.5	7.2	1.5	5.0	1.5	4.8	ns	
tpZH tpZL	Output Enable Time xDIR to A or B		1.5	7.2	1.5	6.2	1.5	5.8	ns	
tPHZ tPLZ	Output Disable Time xDIR to A or B ⁽⁴⁾		1.5	7.2	1.5	5.0	1.5	4.8	ns	
tsk(o)	Output Skew ⁽⁵⁾				0.5		0.5	0.5	ns	

Notes:

1. Propagation Delays and Enable/Disable times are with Vcc = 3.3V ±0.3V, normal range. For Vcc = 2.7V, extended range, all Propagation Delays and Enable/Disable times should be degraded by 20%.
2. See test circuit and wave forms.
3. Minimum limits are guaranteed but not tested on Propagation Delays.
4. This parameter is guaranteed but not production tested.
5. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.
6. All bits switching with 80pFC_L.

Noise Characteristics

Parameters	Description	Conditions	LPT16L245	Units
OS	Overshoot	CL = 20pF	+1V Max.	V
US	Undershoot		-1V Max.	V

Packaging Mechanical: 48-pin TSSOP (A)

Packaging Mechanical: 48-pin SSOP (V)
